



Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at
www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

USB1T1105A

Universal Serial Bus Peripheral Transceiver with Voltage Regulator

General Description

The USB1T1105A is an Universal Serial Bus Specification Rev 2.0 compliant transceiver. The device provides an USB interface for Full-Speed (12Mbit/s) USB applications. The USB1T1105A provides excellent flexibility, allowing differential and single ended inputs while an integrated voltage regulator sets the I/O level to 1.65V to 3.6V. Utilizing an integrated 5.0V to 3.3V voltage regulator, the part can be powered directly from the USB host (V_{BUS}) to minimize the power consumed from the local sources while used in devices with low supply voltages.

The USB1T1105A provides 15kV ESD protection on the USB bus pins (D+/D-). This eliminates the need for any external ESD devices while providing excellent protection to larger and more expensive ASICs and USB controllers.

Features

- Complies with Universal Serial Bus Specification 2.0
- Integrated 5V to 3.3V voltage regulator for powering VBus
- Utilizes digital inputs and outputs to transmit and receive USB cable data
- Supports full speed 12Mbps/s speed data rates
- Ideal for portable electronic devices
- 15kV contact HBM ESD protection on bus pins
- 3.3mm leadless package
- Industry standard HBCC footprint is lead-free

Applications

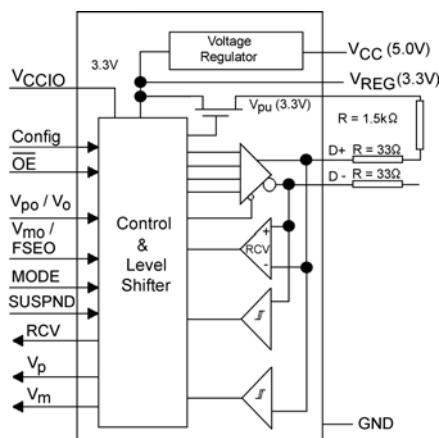
- Cell phone
- PDA
- Digital camera
- MP3

Ordering Code:

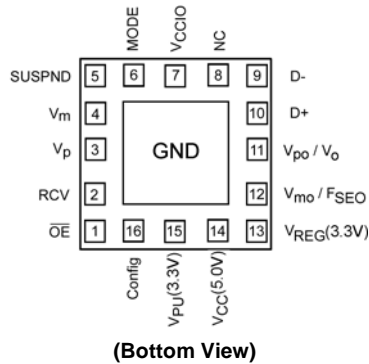
Order Number	Package Number	Package Description
USB1T1105AMHX	MLP16HB	Pb-Free 16-Terminal Molded Leadless Package (MHBCC), JEDEC MO-217, 3mm Square

Pb-Free package per JEDEC J-STD-020B.

Logic Diagram



Connection Diagram



Terminal Descriptions

Terminal Number	Terminal Name	I/O	Terminal Description
1	\overline{OE}	I	Output Enable: Active LOW enables the transceiver to transmit data on the bus. When not active the transceiver is in the receive mode (CMOS level is relative to V_{CCIO})
2	RCV	O	Receive Data Output: Non-inverted CMOS level output for USB differential Input (CMOS output level is relative to V_{CCIO}). Driven LOW when SUSPN is HIGH; RCV output is stable and preserved during SE0 condition.
3	V_p	O	Single-ended D+ receiver output V_p (CMOS level relative to V_{CCIO}): Used for external detection of SEO, error conditions, speed of connected device; Driven HIGH when no supply connected to V_{CC} and V_{REG} .
4	V_m	O	Single-ended D- receiver output V_m (CMOS level relative to V_{CCIO}): Used for external detection of SEO, error conditions, speed of connected device; Driven HIGH when no supply connected to V_{CC} and V_{REG} .
5	SUSPND	I	Suspend: Enables a low power state (CMOS level is relative to V_{CCIO}). While the SUSPND pin is active (HIGH) it will drive the RCV pin to logic "0" state.
6	MODE	I	MODE input (CMOS level is relative to V_{CCIO}). A HIGH selects the differential input MODE (V_{po} , V_{mo}) whereas a LOW enables the single-ended MODE (V_o , V_{FSEO}) see Table 2 and Table 3
7	V_{CCIO}		Supply Voltage for digital I/O pins (1.65V to 3.6V): When not connected the D+ and D- pins are in 3-STATE. This supply bus is totally independent of V_{CC} (5V) and V_{REG} (3.3V).
8	NC	NC	
10, 9	D+, D-	AI/O	Data +, Data -: Differential data bus conforming to the USB standard.
11	V_{po} / V_o	I	Driver Data Input (CMOS level is relative to V_{CCIO}); Schmitt trigger input; see Table 2 and Table 3
12	V_{mo} / F_{SEO}	I	Driver Data Input (CMOS level is relative to V_{CCIO}); Schmitt trigger input; see Table 2 and Table 3
13	V_{REG} (3.3V)		Internal Regulator Option: Regulated supply output voltage (3.0V to 3.6V) during 5V operation; decoupling capacitor of at least 0.1 μ F is required.
14	V_{CC} (5.0V)		Internal Regulator Option: Used as supply voltage input (4.0V to 5.5V); can be connected directly to USB line Vbus.

Terminal Number	Terminal Name	I/O	Terminal Description
15	V _{PU} (3.3V)		Pull-up Supply Voltage (3.3V \pm 10%); Connect an external 1.5k Ω resistor on D+ (FS data rate); Pin function is controlled by Config input pin: Config = LOW – V _{PU} (3.3V) is floating (High Impedance) for zero pull-up current. Config = HIGH – V _{PU} (3.3V) = 3.3V; internally connected to V _{REG} (3.3V).
16	Config	I	USB connect or disconnect software control input. Configures 3.3V to external 1.5k Ω resistor on D+ when HIGH.
Exposed Diepad	GND	GND	GND supply down bonded to exposed diepad to be connected to the PCB GND.

Functional Description

The USB1T1105A transceiver is designed to convert CMOS data into USB differential bus signal levels and to convert USB differential bus signal to CMOS data.

To minimize EMI and noise the outputs are edge rate controlled with the rise and fall times controlled and defined for full speed data rates. The rise, fall times are balanced between the differential pins to minimize skew.

Table 1 describes the specific pin functionality selection. Table 2, Table 3, and Table 4 describe the specific Truth Tables for Driver and Receiver operating functions.

The USB1T1105A also has the capability of various power supply configurations to support mixed voltage supply applications (see Table 5) and Power Supply Configurations and Options for detailed descriptions.

Functional Tables

TABLE 1. Function Select

SUSPND	$\overline{\text{OE}}$	D+, D–	RCV	V _p /V _m	Function
L	L	Driving & Receiving	Active	Active	Normal Driving (Differential Receiver Active)
L	H	Receiving (Note 1)	Active	Active	Receiving
H	L	Driving	Inactive (Note 2)	Active	Driving during Suspend (Differential Receiver Inactive)
H	H	3-STATE (Note 1)	Inactive (Note 2)	Active	Low Power State

Note 1: Signal levels is function of connection and/or pull-up/pull-down resistors.

Note 2: For SUSPND = HIGH mode the differential receiver is inactive and the output RCV output is forced LOW. The out-of-suspend signaling (K) is detected via the single-ended receiver outputs of the V_p and V_m pins.

TABLE 2. Driver Function ($\overline{\text{OE}} = \text{L}$) using Differential Input Interface Mode Pin = H

V _{mo}	V _{po}	Data
L	L	SE0 (Note 3)
L	H	Differential Logic 1
H	L	Differential Logic 0
H	H	Illegal State

Note 3: SE0 = Single Ended Zero

TABLE 3. Driver Function ($\overline{\text{OE}} = \text{L}$) using Single-ended Input Interface Mode Pin = L

FSE0	V _o	Data
L	L	Differential Logic 0
L	H	Differential Logic 1
H	L	SE0 (Note 4)
H	H	SE0 (Note 4)

Note 4: SE0 = Single Ended Zero

TABLE 4. Receiver Function ($\overline{OE} = H$)

D+, D-	RCV	V _p	V _m
Differential Logic 1	H	H	L
Differential Logic 0	L	L	H
SE0	X	L	L
Sharing Mode	L	H	H

X = Don't Care

Power Supply Configurations and Options

The three modes of power supply operation are:

- Normal Mode: Regulated Output and Regulator Bypass
 1. Regulated Output: V_{CCIO} is connected and V_{CC} (5.0) is connected to 5V (4.0V to 5.5V) and the internal voltage regulator then produces 3.3V for the USB connections.
 2. Internal Regulator Bypass Mode: V_{CCIO} is connected and both V_{CC}(5.5) and V_{REG}(3.3) are connected to a 3.3V source (3.0V to 3.6V).

In both cases for normal mode the V_{CCIO} is an independent voltage source (1.65V to 3.6V) that is a function of the external circuit configuration.
- Sharing Mode: V_{CCIO} is only supply connected. V_{CC} and V_{REG} are not connected. In this mode the D+ and D- pins are

3-STATE and the USB1T1105A allows external signals up to 3.6V to share the D+ and D- bus lines. Internally the circuitry limits leakage from D+ and D- pins (maximum 10 μ A) and V_{CCIO} such that device is in low power (suspended) state. Terminals Vbusmon and RCV are forced LOW as an indication of this mode with Vbusmon being ignored during this state.

- Disable Mode: V_{CCIO} is not connected. V_{CC} is connected, or V_{CC} and V_{REG} are connected. 0V to 3.3V in this mode D+ and D- are 3-STATE and V_{PU} is HIGH Impedance (switch is turned off). The USB1T1105A allows external signals up to 3.6V to share the D+ and D- bus lines. Internally the circuitry limits leakage from D+ and D- terminals (maximum 10 μ A).

A summary of the Supply Configurations is described in Table 5.

TABLE 5. Power Supply Configuration Options

Pins	Power Supply Mode Configuration			
	Sharing	Disable	Normal (Regulated Output)	Normal (Regulator Bypass)
V _{CC} (5V)	< 3.6V	Connected to 5V Source	Connected to 5V Source	Connected to V _{REG} (3.3V) [max drop of 0.3V] (2.7V to 3.6V)
V _{REG} (3.3V)	Pulled LOW Regulator OFF	3.3V, 300 μ A Regulated Output	3.3V, 300 μ A Regulated Output	Connected to 3.3V Source
V _{CCIO}	1.65V to 3.6V Source	Not Connected	1.65V to 3.6V Source	1.65V to 3.6V Source
V _{PU} (3.3V)	3-STATE (Off)	3-STATE (Off)	3.3V Available if Config = HIGH	3.3V Available if Config = HIGH
D+, D-	3-STATE	3-STATE	Function of Mode Set Up	Function of Mode Set Up
V _p , V _m	H	Invalid	Function of Mode Set Up	Function of Mode Set Up
RCV	L	Invalid	Function of Mode Set Up	Function of Mode Set Up
OE, SUSPND, Config, V _{po} /V _o , V _{mo} /F _{SEO} , MODE	Hi-Z	Hi-Z	Function of Mode Set Up	

Note 5: Hi-Z or forced LOW.

Absolute Maximum Ratings(Note 6)

Supply Voltage (V_{CC})(5V)	-0.5V to +6.0V
I/O Supply Voltage (V_{CCIO})	-0.5V to +4.6V
Latch-up Current (I_{LU})	
$V_I = -1.8V$ to $+5.4V$	150 mA
DC Input Current (I_{IK})	
$V_I < 0$	-18 mA
DC Input Voltage (V_I)	
(Note 7)	-0.5V to $V_{CCIO} + 0.5V$
DC Output Diode Current (I_{OK})	
$V_O > V_{CC}$ or $V_O < 0$	± 18 mA
DC Output Voltage (V_O)	
(Note 7)	-0.5V to $V_{CCIO} + 0.5V$
Output Source or Sink Current (I_O)	
$V_O = 0$ to V_{CC}	
Current for D+, D- Pins	± 12 mA
Current for RCV, V_m/V_p	± 12 mA
DC V_{CC} or GND Current	
(I_{CC} , I_{GND})	± 100 mA
ESD Immunity Voltage (V_{ESD});	
Contact HBM	
Pins D+, D-, and GND	15kV
All Other Pins	2.5kV
Storage Temperature (T_{STO})	-40°C to + 125°C
Power Dissipation (P_{TOT})	
I_{CC} (5V)	48 mW
I_{CCIO}	9 mW

Recommended Operating Conditions

DC Supply Voltage V_{CC} (5V)	4.0V to 5.5V
I/O DC Voltage V_{CCIO}	1.65V to 3.6V
DC Input Voltage Range (V_I)	0V to $V_{CCIO} + 0.5V$
DC Input Range for AI/O ($V_{IA/O}$)	0V to 3.6V
Pins D+ and D-	0V to 3.6V
Operating Ambient Temperature	
(T_{AMB})	-40°C to +85°C

Note 6: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristic tables are not guaranteed at the absolute maximum rating. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 7: IO Absolute Maximum Rating must be observed.

DC Electrical Characteristics (Supply Pins)

Over recommended range of supply voltage and operating free air temperature (unless otherwise noted).
 V_{CC} (5V) = 4.0V to 5.5V or V_{REG} (3.3V) = 3.0V to 3.6V, V_{CCIO} = 1.65V to 3.6V

Symbol	Parameter	Conditions	Limits			Units
			−40°C to +85°C			
			Min	Typ	Max	
V _{REG} (3.3V)	Regulated Supply Output	Internal Regulator Option; I _{LOAD} ≤ 300 μA	3.0 (Note 8)(Note 9)	3.3	3.6	V
I _{CC}	Operating Supply Current (V _{CC} 5.0)	Transmitting and Receiving at 12 Mbits/s; C _{LOAD} = 50 pF (D+, D−)		4.0 (Note 10)	8.0	mA
I _{CCIO}	I/O Operating Supply Current	Transmitting and Receiving at 12 Mbits/s		1.0 (Note 10)	2.0	mA
I _{CC} (IDLE)	Supply Current during FS IDLE and SE0 (V _{CC} 5.0)	IDLE: V _{D+} ≥ 2.7V, V _{D−} ≤ 0.3V; SE0: V _{D+} ≤ 0.3V, V _{D−} ≤ 0.3V			500 (Note 11)	μA
I _{CCIO} (STATIC)	I/O Static Supply Current	IDLE, SUSPND or SE0			20.0	μA
I _{CC} (SUSPND)	Suspend Supply Current USB1T1105A	SUSPND = HIGH OE = HIGH V _m = V _p = OPEN			25.0 (Note 11)	μA
I _{CCIO} (SHARING)	I/O Sharing Mode Supply Current	V _{CC} (5V) Not Connected			20.0	μA

DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	Limits			Units
			−40°C to +85°C			
			Min	Typ	Max	
I _{D±(SHARING)}	Sharing Mode Load Current on D+/D− Pins	V _{CC} (5V) Not Connected Config = LOW; V _{D±} = 3.6V			10.0	μA
V _{CC_{TH}}	V _{CC} Threshold Detection Voltage	1.65V ≤ V _{CCIO} ≤ 3.6V				V
		Supply Lost			3.6	
		Supply Present	4.1			
V _{CC_{HYS}}	V _{CC} Threshold Detection Hysteresis Voltage	V _{CCIO} = 1.8V		70.0		mV
V _{CCIO_{TH}}	V _{CCIO} Threshold Detection Voltage	2.7V ≤ V _{REG} ≤ 3.6V				V
		Supply Lost			0.5	
		Supply Present	1.4			
V _{CCIO_{HYS}}	V _{CCIO} Threshold Detection Hysteresis Voltage	V _{REG} = 3.3V		450		mV

Note 8: I_{LOAD} includes the pull-up resistor current via pin V_{PU}

Note 9: The minimum voltage in Suspend mode is 2.7V.

Note 10: Not tested in production, value based on characterization.

Note 11: Excludes any current from load and V_{PU} current to the 1.5k Ω resistor.

Note 12: Includes current between V_{pu} and the 1.5k internal pull-up resistor.

Note 13: When $V_{CCIO} < 2.7V$, minimum value for $V_{REG\text{TH}} = 2.0V$ for supply present condition.

DC Electrical Characteristics (Digital Pins – excludes D+, D- Pins)

Over recommended range of supply voltage and operating free air temperature (unless otherwise noted). $V_{CCIO} = 1.6V$ to 3.6V

Symbol	Parameter	Test Conditions	Limits		Units
			−40°C to +85°C		
			Min	Max	
Input Levels					
V _{IL}	LOW Level Input Voltage			0.3	V
V _{IH}	HIGH Level Input Voltage		0.6*V _{CCIO}		V
V _{HYS}	Hysteresis Voltage P11 + P12	Pins V _{po} /V _{mo} , V _{CCIO} = 3.3V	0.3	0.7	V
Output Levels					
V _{OL}	LOW Level Output Voltage	I _{OL} = 2 mA		0.4	V
		I _{OL} = 100 μA		0.15	
V _{OH}	HIGH Level Output Voltage	I _{OH} = 2 mA	V _{CCIO} - 0.4		V
		I _{OH} = 100 μA	V _{CCIO} - 0.15		
Leakage Current					
I _{LI}	Input Leakage Current	V _{CCIO} = 1.65V to 3.6V		±1.0 (Note 14)	μA
Capacitance					
C _{IN} , C _{I/O}	Input Capacitance	Pin to GND		10.0	pF

Note 14: If $V_{CCIO} \geq V_{REG}$ then leakage current will be higher than specified.

DC Electrical Characteristics (Analog I/O Pins – D+, D– Pins)

Over recommended range of supply voltage and operating free air temperature (unless otherwise noted). $V_{CC} = 4.0V$ to $5.5V$ or $V_{REG} = 3.0V$ to $3.6V$

Symbol	Parameter	Test Condition	Limits			Units
			−40°C to +85°C			
			Min	Typ	Max	
Input Levels – Differential Receiver						
V _{DI}	Differential Input Sensitivity	V _{I(D+)} - V _{I(D-)}	0.2			V
V _{CM}	Differential Common Mode Voltage		0.8		2.5	V
Input Levels – Single-ended Receiver						
V _{IL}	LOW Level Input Voltage				0.8	V
V _{IH}	HIGH Level Input Voltage		2.0			V
V _{HYS}	Hysteresis Voltage		0.4		0.7	V
Output Levels						
V _{OL}	LOW Level Output Voltage	R _L = 1.5kΩ to 3.6V			0.3	V
V _{OH}	HIGH Level Output Voltage	R _L = 15kΩ to GND	2.8 (Note 15)		3.6	V
Leakage Current						
I _{LZ}	Input Leakage Current Off State	$\overline{OE} = H$			±1.0	μA
Capacitance						
C _{I/O}	I/O Capacitance	Pin to GND			20.0	pF
Resistance						
Z _{DRV}	Driver Output Impedance		34.0	41.0 (Note 16)	44.0	Ω
Z _{IN}	Driver Input Impedance		10.0			MΩ
R _{SW}	Switch Resistance				10.0	Ω
V _{TERM}	Termination Voltage	R _{PU} Upstream Port	3.0 (Note 17) (Note 18)		3.6	V

Note 15: $V_{OH} \text{ min.} = V_{REG} - 0.2V$.

Note 16: Includes external resistors of 33Ω on both D+ and D– pins.

Note 17: This voltage is available at pin V_{PU} and V_{REG} .

Note 18: Minimum voltage is 2.7V in the suspend mode.

AC Electrical Characteristics (A I/O Pins Full Speed)

Over recommended range of supply voltage and operating free air temperature (unless otherwise noted). $V_{CC} = 4.0V$ to $5.5V$ or $V_{REG} = 3.0V$ to $3.6V$, $V_{CCIO} = 1.65V$ to $3.6V$, $C_L = 50$ pF; $R_L = 1.5K$ on $D+$ to V_{PU}

Symbol	Parameter	Test Conditions	Limits			Unit
			-40° C to +85° C			
			Min	Typ	Max	
Driver Characteristics						
t _{FR}	Output Rise Time	C _L = 50 – 125 pF 10% to 90%	4.0		20.0	ns
t _{FF}	Output Fall Time	Figures 1, 5	4.0		20.0	
t _{RFM}	Rise/Fall Time Match	t _F / t _R Excludes First Transition from Idle State	90.0		111.1	%
V _{CRS} (Note 19)	Output Signal Crossover Voltage	Excludes First Transition from Idle State see Waveform	1.3		2.0	V
Driver Timing						
t _{PLH} t _{PHL}	Propagation Delay (V _P /V _{PO} , V _M /V _{MO} to D+/D-)	Figures 2, 5			18.0	ns
t _{PHZ} t _{PLZ}	Driver Disable Delay (\overline{OE} to D+/D-)	Figures 4, 6			15.0	ns
t _{PZH} t _{PZL}	Driver Enable Delay (\overline{OE} to D+/D-)	Figures 4, 6			15.0	ns
Receiver Timing						
t _{PLH} t _{PHL}	Propagation Delay (Diff) (D+/D- to Rev)	Figures 3, 7			15.0	ns
t _{PLH} t _{PHL}	Single Ended Receiver Propagation Delay (D+/D- to V _P / V _{PO} , V _M /V _{MO})	Figures 3Figure 7			18.0	ns

Note 19: Not production tested, guaranteed by characterization.

AC Waveforms

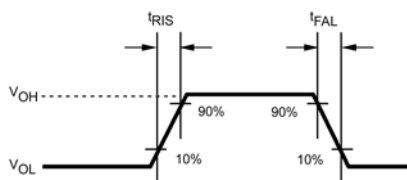


FIGURE 1. Rise and Fall Times

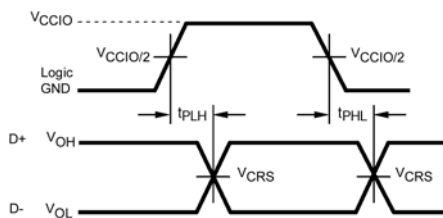


FIGURE 2. V_{po}/V_o , V_{mo}/V_{SEO} to D+/D-

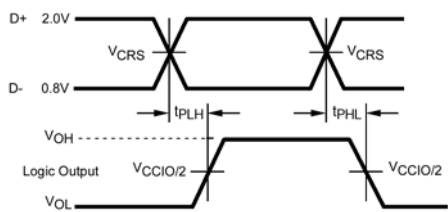


FIGURE 3. D+/D- to R_{CV} , V_p and V_m

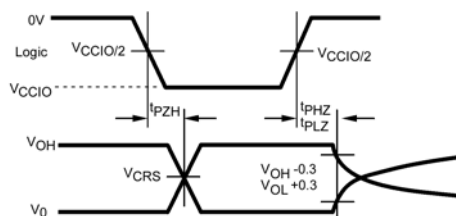
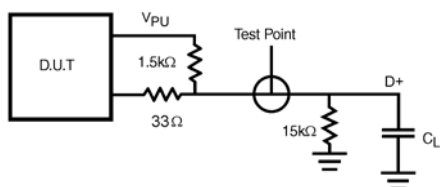


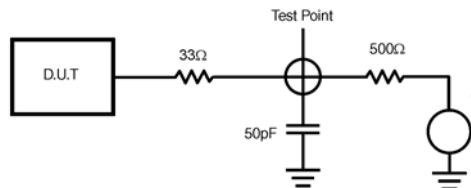
FIGURE 4. \overline{OE} to D+/D-

Test Circuits and Waveforms



$C_L = 50 \text{ pF}$ Full Speed Propagation Delays
 $C_L = -125 \text{ pF}$ Edge Rates only

FIGURE 5. Load for D+/D-



$V = 0$ for t_{PZH} , t_{PHZ}
 $V = V_{REG}$ for t_{PZL}

FIGURE 6. Load for Enable and Disable Times

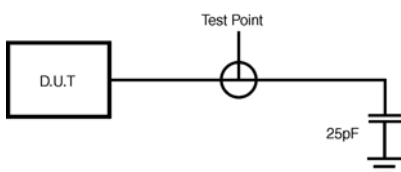


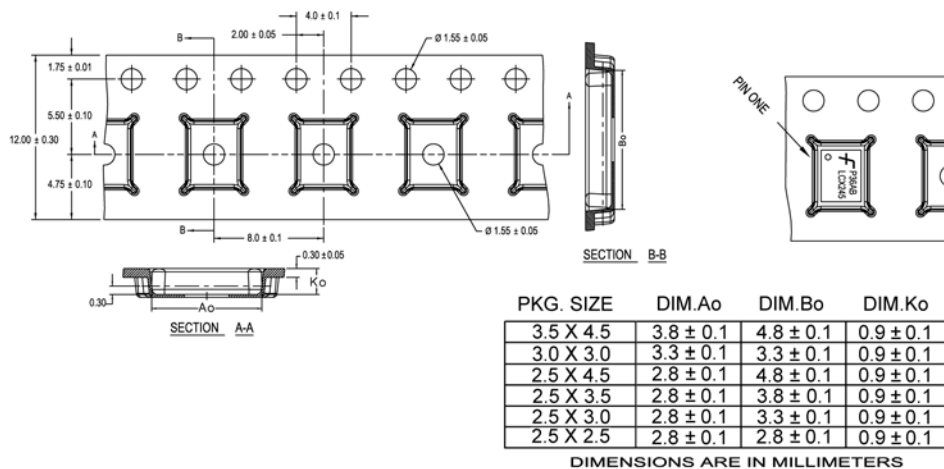
FIGURE 7. Load for V_m/V_{mo} , V_p/V_{po} and R_{CV}

Tape and Reel Specification

Tape Format for MHBCC

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
MHX	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	2500/3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

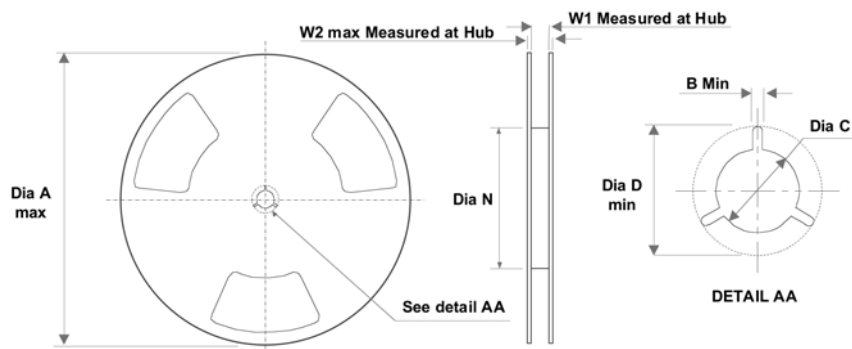
TAPE DIMENSIONS inches (millimeters)



NOTES: unless otherwise specified

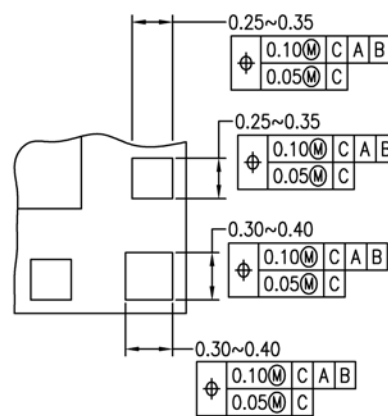
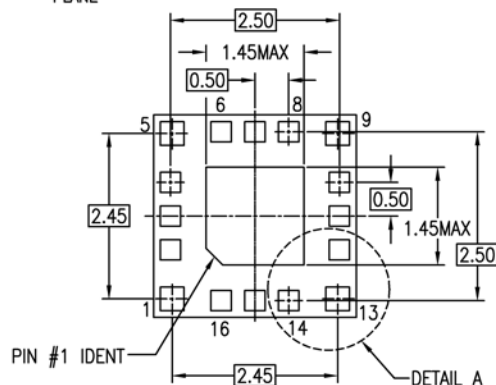
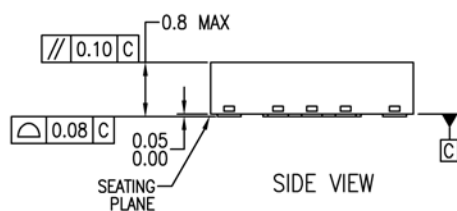
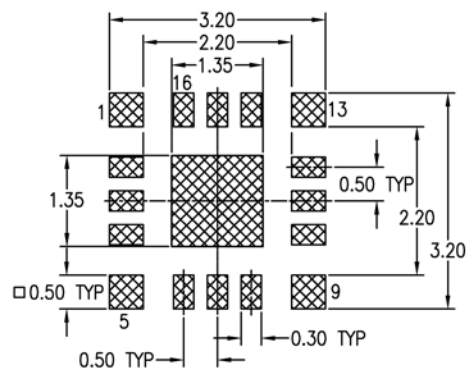
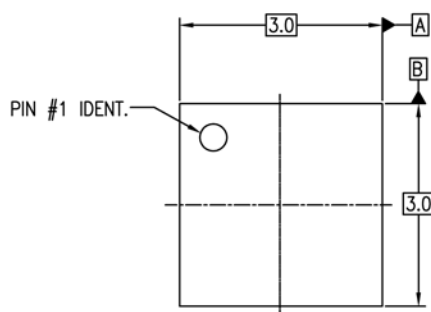
1. Cumulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.008[0.20] over 10 pitch span.
2. Smallest allowable bending radius.
3. Thru hole inside cavity is centered within cavity.
4. Tolerance is $\pm 0.002[0.05]$ for these dimensions on all 12mm tapes.
5. Ao and Bo measured on a plane 0.120[0.30] above the bottom of the pocket.
6. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
8. Controlling dimension is millimeter. Dimension in inches rounded.

REEL DIMENSIONS inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2
12 mm	13.0	0.059	0.512	0.795	7.008	0.488	0.724
	330	(1.50)	(13.00)	(20.20)	(178)	(12.4)	(18.4)

Physical Dimensions inches (millimeters) unless otherwise noted



NOTES:

- A. SIMILAR TO JEDEC REGISTRATION MO-217, DATED 11/2001
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP16HBrevA

**Pb-Free 16-Terminal Molded Leadless Package (MHBCC), JEDEC MO-217, 3mm Square
Package Number MLP16HB**

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use

provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada

Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910

Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local
Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor:](#)

[USB1T1105AMHX](#)

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: org@lifeelectronics.ru

www.lifeelectronics.ru